

3mm Round Standard T-1 With Flange Type Silicon PIN Photodiode Technical Data Sheet

Part No.: LL-304PDD2E

Spec No.: B302 X440 Rev No.: V.2 Date: Sep/17/2005 Page: 1 OF 7

Approved: 34000 Checked: Wu Drawn: Qin



Features:

- ♦ Fast response time.
- ♦ High photo sensitivity.
- ♦ Small junction capacitance.
- ♦ The product itself will remain within RoHS compliant Version.

Descriptions:

The 304PD is a high speed and high sensitive PIN photodiode in a standard 3φ plastic package. Due to its water clear epoxy the device is sensitive to visible and infrared radiation.

Applications:

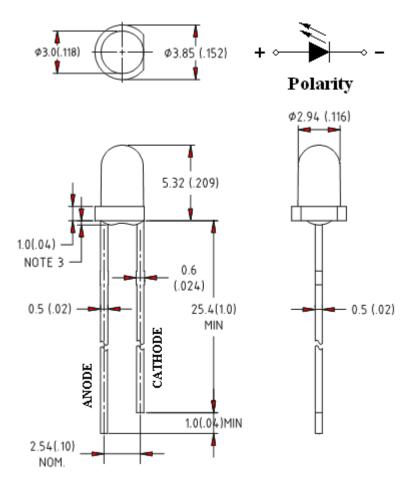
- ♦ High speed photo detector.
- ♦ Security system.
- ♦ Game machine.

Spec No.: B302 X440 Rev No.: V.2 Date: Sep/17/2005 Page: 2 OF 7

Approved: 34000 Checked: Wu Drawn: Qin



Package Dimension:



| Part No. | Chip Material | Lens Color | Source Color |
|-------------|---------------|------------|-------------------|
| LL-304PDD2E | Silicon | Black | Infrared Receiver |

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.25 mm (.010") unless otherwise noted.
- 3. Protruded resin is 1.00 mm (.039") max.
- 4. Specifications are subject to change without notice.

Spec No.: B302 X440 Rev No.: V.2 Date: Sep/17/2005 Page: 3 OF 7

Approved: 34000 Checked: Wu Drawn: Qin



Absolute Maximum Ratings at Ta=25 $^{\circ}$ C

| Parameters | Symbol | Max. | Unit | |
|---|--------|--------------|------|--|
| Power Dissipation | PD | 150 | mW | |
| Reverse Voltage | VR | 32 | V | |
| Operating Temperature Range | Topr | -25℃ to +80℃ | | |
| Storage Temperature Range | Tstg | -40℃ to +85℃ | | |
| Lead Soldering Temperature [4mm (.157") From Body] | Tsld | 260℃ | | |

Electrical Optical Characteristics at Ta=25 $^{\circ}$ C

| Parameters | Symbol | Min. | Тур. | Max. | Unit | Test Condition |
|----------------------------|-----------------|------|------|------|------|--|
| Rang of Spectral Bandwidth | λ0.5 | 840 | | 1100 | nm | |
| Open-Circuit Voltage | Voc | | 0.42 | | V | Ee=5mW/cm² λp=940nm |
| Short-Circuit Current | I_{SC} | | 30 | | μΑ | Ee=1mW/cm ² , λ =940nm |
| Peak Emission Wavelength | λр | | 940 | | nm | IF=20mA (Note 3) |
| Reverse Light Current | IL | | 3 | | μΑ | $V_R=5V$, $Ee=1mW/cm^2$ $\lambda=940nm$ |
| Dark Current | I_{D} | | | 10 | nA | V _R =10V, Ee=0mW/m ² |
| Reverse Breakdown | B _{VR} | 32 | 170 | | V | IR=100µA, Ee=0mW/cm ² |
| Total Capacitance | C _t | | 5 | | pF | Ee=0mW/cm ² , VR=5V, f=1MHZ |
| Rise Time (10% to 90%) | Tr | | 6 | | nS | V _R =10V, R _L =100Ω, |
| Fall Time (90% to 10%) | Tf | | 6 | | 113 | |

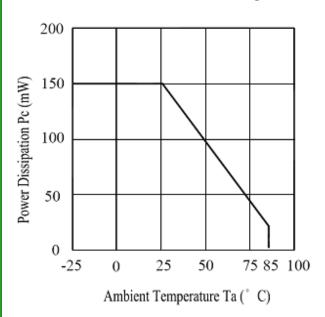
Spec No.: B302 X440 Rev No.: V.2 Date: Sep/17/2005 Page: 4 OF 7

Approved: 34000 Checked: Wu Drawn: Qin

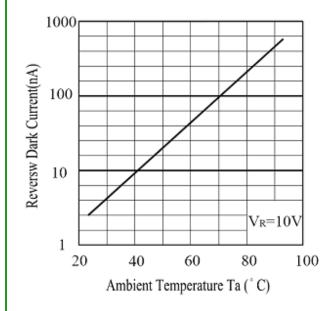


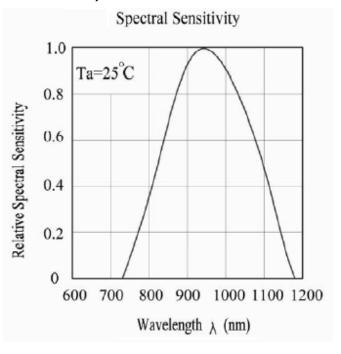
Typical Electrical / Optical Characteristics Curves (25°C Ambient Temperature Unless Otherwise Noted)

Power Dissipation vs. Ambient Temperature

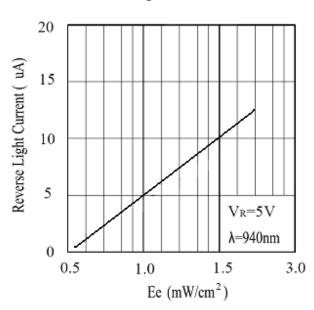


Dark Current vs. Ambient Temperature





Reverse Light Current vs. Ee

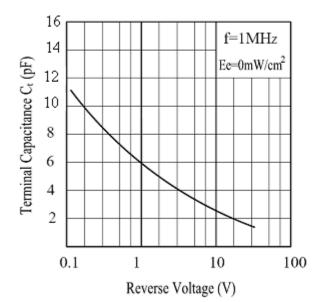


Spec No.: B302 X440 Rev No.: V.2 Date: Sep/17/2005 Page: 5 OF 7

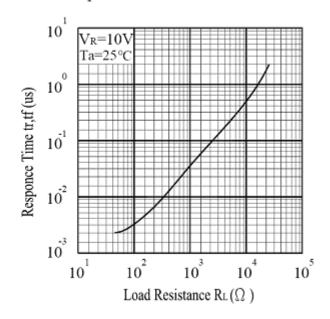
Approved: 34000 Checked: Wu Drawn: Qin



Terminal Capacitance vs. Reverse Voltage



Response Time vs. Load Resistance



Spec No.: B302 X440 Rev No.: V.2 Date: Sep/17/2005 Page: 6 OF 7 Approved: 3400 Checked: Wu Drawn: Qin

Approved: 3401 Checked: Wu Lucky Light Electronics Co., Ltd.

http://www.luckylightled.com



Please read the following notes before using the datasheets:

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30℃ or less and 70%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

3. Soldering Condition

- 3.1 Pb-free solder temperature profile.
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260℃ for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

6. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices equipment and machinery must be properly grounded.

Spec No.: B302 X440 Rev No.: V.2 Date: Sep/17/2005 Page: 7 OF 7

Approved: 3400 Checked: Wu Drawn: Qin